Data Sheets of AVA Technology SMD Hi-Power White LED

Model: T6W6C

AVA Technology Co.

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http://www.led4light.com

Top View Hi-Power White LED with Reflector

1. FEATURES

- High intensity with small package, ideal for backlighting
- Wide viewing angle (120°)
- Package Outline (L×W×H)=7.4×5.0×1.3 mm
- Technology: InGaN
- Color coordinates CIE(x,y): (0.31,0.31) according to CIE 1931.
- Suitable for all SMT assembly methods
- Operating Power Consumption : 0.80W
- Mount on MCPCB have good Thermal Dissipation and Excellent Life
- Suitable for all soldering methods
- Delivery on 12mm tape reels
- Suitable for Lead-free process



- Automotive: indoor/outdoor lighting.
- Signal and symbol lightings
- Backlighting (Large LCD.....)
- All applications in notice high intensities are required
- Strobe Light
- Channel Letter
- Decorative Light
- General Lighting

3. DEVICES PACKAGE

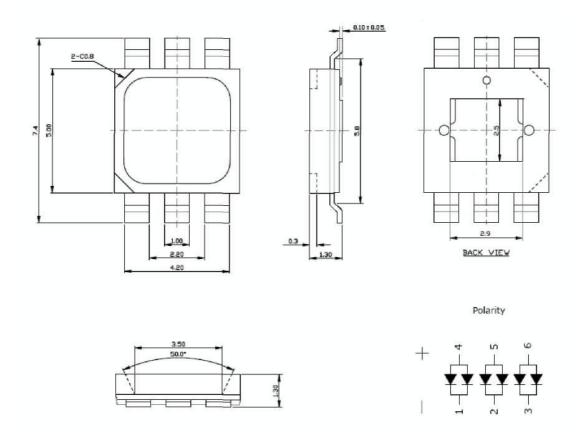
ITEM	MATERIALS				
Package	Heat-Resistant Polymer				
Encapsulating	Heat Resistance Resin				
Electrodes	Ag Plating Copper Alloy				

Туре	Color of Emission	Color of the Light Emitting Area	$\begin{array}{c} Luminous\ intensity\\ Iv\ (mcd)\\ I_F = 210mA \end{array}$	
T6W6C	White	Colored	8400 ~20000	



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4. OUTLINE DIMENSION:



Note:

1. Unit: mm

2. Tolerance: Dimension ± 0.1 /Angle $\pm~0.5^{\circ}$

5. ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}C$)

Parameter	Symbol	Absolute Max. Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	240	mA
Operating Temperature	Topr	-30 ~ +65	°C
Storage Temperature	Storage Temperature T _s tg -40~+100		°C
Soldering Temperature	Tsol	260 (for 5 sec)	°C
Power Consumption	PD	1.0 (6 chips ON)	W
Peak Forward Current (Duty 1/10 @ 1KHz)	I _F (peak)	480 (6 chips ON)	mA
Junction temperature	Tj	120	°C
Thermal Resistance (Junction to ambient)	Rth,JA	60	°c/w

6. ELECTRONIC OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Chromaticity coordinate x acc. To CIE 1931	X	IF=210mA	_	0.31		_
Chromaticity coordinate y acc. To CIE 1931	у	IF=210mA	_	0.31	_	
Correlated Color Temperature	ССТ	IF=210mA	_	6900	_	K
Viewing Angle	201/2	IF=210mA		120		Degree
Forward Voltage	V_{F}	IF=210mA		3.40	3.80	V
Leakage Current	IR	VR=-5V		_	50	μΑ

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7. LUMINOUS INTENSITY GROUPS:

Luminous intensity	Measurement condition	Luminous intensity Iv(mcd)
group	Collattion	Tv(IIICu)
X2		15000-20000
X1	I = 210 m A	12000-15000
W9	$I_F = 210 \text{ mA}$	10000-12000
W8		8400-10000

^{*}Luminous intensity group includes 4 groups W8 to X2.

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^{*}Luminous intensity is tested at a current pulse duration of 25ms and a tolerance of \pm 10%



8. CHROMATICITY COORDINATES RANKS:

Forward Current, IF=20mA									
Rank		CIE	CCT(°K)	Dank	Rank		CCT(°K)		
Kalik	Х	У	CCI(°K)	Kalik	Х	У	CCI(°K)		
	0.2640	0.2670			0.2870	0.2950			
a31	0.2690	0.2610		b51	0.26900	0.2885			
азі	0.2790	0.2760		DSI	0.3020	0.3000			
	0.2760	0.2810			0.3000	0.3080			
	0.2690	0.2610			0.26900	0.2885			
a32	0.2770	0.2520	11500-15000	b52	0.2950	0.2785	7600-9000		
a32	0.2850	0.2665	11300-13000	(b74)	0.3060	0.2875	7000-9000		
	0.2790	0.2760			0.3020	0.3000			
	0.2770	0.2535			0.2950	0.2785			
a36	0.2840	0.2460		b73	0.3000	0.2690			
a30	0.2910	0.2570		D/3	0.3080	0.2790	l		
	0.2850	0.2665			0.3060	0.2875			
	0.2790	0.2760			0.2980	0.3150			
a33	0.2850	0.2665		b33	0.3000	0.3080			
(b71)	0.2950	0.2785			0.3070	0.3150			
	0.2900	0.2885			0.3055	0.3220			
	0.2760	0.2810			0.2960	0.3210			
- 21	0.2790	0.2760	9000-11500	9000-11500	0000 11500	h24	0.2980	0.3150	
a34	0.2900	0.2885			b34	0.3055	0.3220		
	0.2870	0.2950			0.3040	0.3300	l		
	0.2850	0.2665			0.3020	0.3000			
h72	0.2910	0.2570		b53	0.3060	0.2875	7000-7600		
b72	0.3000	0.2690		(b81)	0.3110	0.2940	7000-7600		
	0.2950	0.2785			0.3085	0.3075			
	0.2830	0.3070			0.30	0.3080			
L 21	0.2853	0.3000		1a F 4	0.3000	0.3000			
b31	0.2980	0.3150	- 7600-9000 -	b54	0.3085	0.3075			
	0.2960	0.3210			0.3070	0.3150			
	0.2853	0.30600			0.3060	0.2875			
b 20	0.2870	0.2950		hoo	0.3080	0.2790			
b32 –	0.3000	0.3080		b82	0.3130	0.2850			
	0.2980	0.3150	-		0.3110	0.2940			

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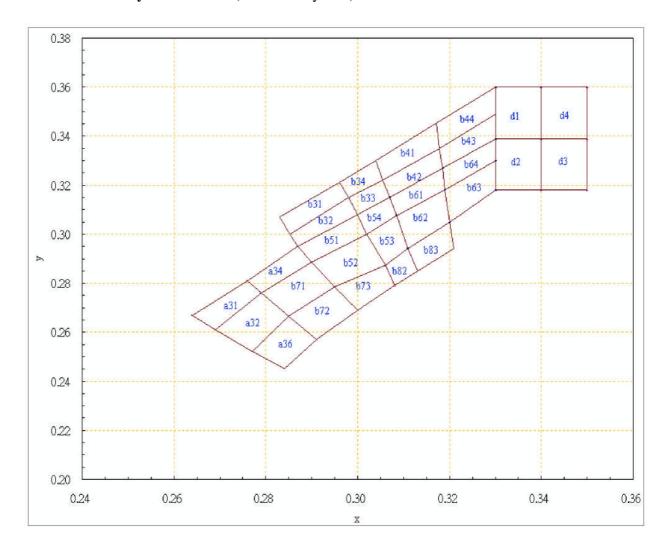
Forward Current, IF=210mA									
Dank	Rank CIE		CCT(°K)	Dank	CIE		CCT(°K)		
ralik	Х	У	CCI(-K)	Rank	Х	У	CCI(-K)		
	0.3040	0.3300			0.3190	0.3180			
b41	0.3055	0.3220		b63	0.3050	0.3050			
D41	0.3177	0.3350			0.3180	0.3180			
	0.3172	0.3452			0.3300	0.3300	E000 6E00		
	0.3055	0.3220			0.3185	0.3270	5000-6500		
b42	0.3070	0.3150	6000-7000	b64	0.3190	0.3180			
D42	0.3185	0.3270	0000-7000	D64	0.3300	0.3300			
	0.3177	0.3350			0.3300	0.3390			
	0.3070	0.3150			0.3600	0.3600			
b61	0.3085	0.3075		d1	0.3390	0.3390			
DOI	0.3190	0.3180		a i	0.3400	0.3390			
	0.3185	0.3270			0.3400	0.3600			
	0.3085	0.3075	0.3075 0.2940 0.3050 0.3180 0.2940 0.2850 0.2940		0.3390	0.3390			
b62	0.3110	0.2940		d2	0.3300	0.3180			
(b84)	0.3200	0.3050			0.3400	0.3180			
	0.3190	0.3180			0.3400	0.3390	4700 5500		
	0.3110	0.2940			0.3390	0.3390	4700-5500		
b83	0.3130	0.2850				d3	0.3400	0.3180	
203	0.3210	0.2940		u.s	0.3500	0.3180			
	0.3200	0.3050			0.3500	0.3390			
	0.3177	0.3350			0.3400	0.3600			
b43	0.3185	0.3270		d4	0.3400	0.3390			
D43	0.3300	0.3390		u4	0.3500	0.3390			
	0.3300	0.3490	5000-6500		0.3500	0.3600			
	0.3172	0.3452	2000-0200						
b44	0.3177	0.3350							
D44	0.3300	0.3490							
	0.3300	0.3600							

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^{*} Tolerance of the chromaticity coordinate is ± 0.007 * CCT (Correlated Color Temperature) Tolerance is $\pm 300~K$

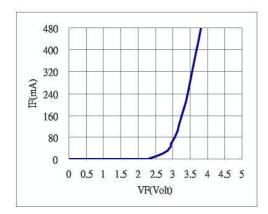
9. TYPICAL ELECTRO-OPTICAL CHATACTERISTIC CURVES:

* Chromaticity Coordinates (CIE 1931 system)

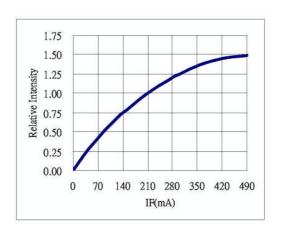


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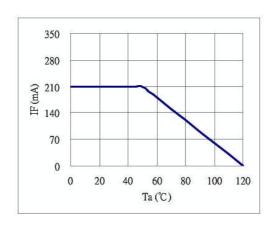
* Forward Voltage vs. Forward Current @25°C



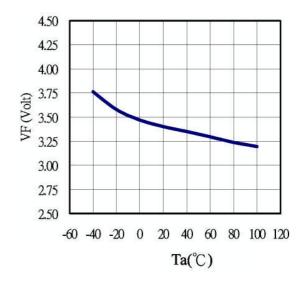
Forward Current vs. Relative Luminosity@25°C



* Ambient Temperature vs. Allowable Forward Current



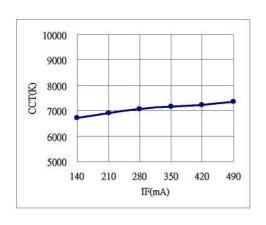
* Ambient Temperature vs. Forward Voltage@20mA

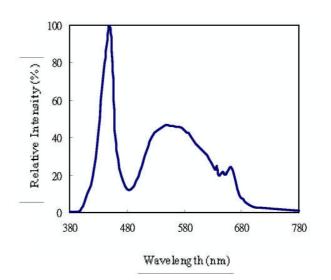


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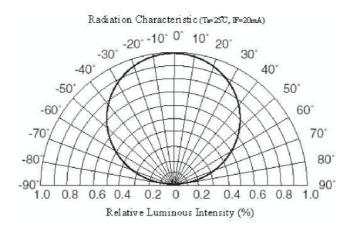
* Forward Current vs. Correlated Color Temperature @ 25°C







* Radiation Characteristic (@25°C, 210mA)



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10. RELIABILITY PLAN:

* The reliability of products shall be satisfied with items listed below.

Confidence Level: 90 %, LTPD: 10 %

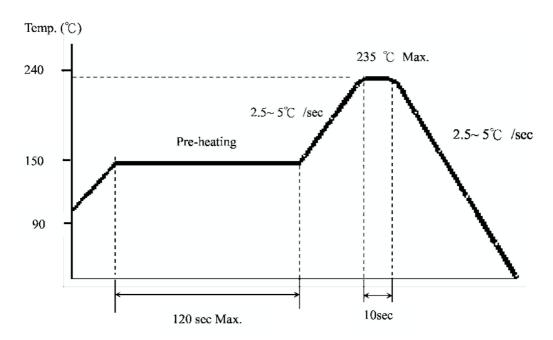
No	Test Item	Description & Condition		Sample size	Ac/Re	Failure Criteria
1	Solderability	Tsld=235±5°C,10sec,	1 time	15	0/1	
2	Room Temperature operating	$Ta = 25$ °C $I_F = 210 \text{ mA}$	1000 hrs	15	0/1	IV <l*0.6 (I_F: 20mA)</l*0.6
3	Room Temperature operating	$Ta = 25$ °C $I_F = 300 \text{ mA}$	500 hrs	15	0/1	$V_F>U*1.1$ $(I_F: 20mA)$ $I_R>U*2.0$
4	Low Temperature Storage	$Ta = -40^{\circ}C$	1000 hrs	15	0/1	(V _R :5V)
5	High Temperature Storage	Ta=100°C	1000 hrs	15	0/1	L: Lower Spec. Level
6	Temperature Cycle	-40°C ~ 25°C ~ 100°C ~ 25 °C 30min 5min 30min 5 min	300 cycles	15	0/1	U: Upper Spec.
7	High Humidity Heat	Ta = 60°C RH=90% I _F = 210 mA	500 hrs	15	0/1	Level

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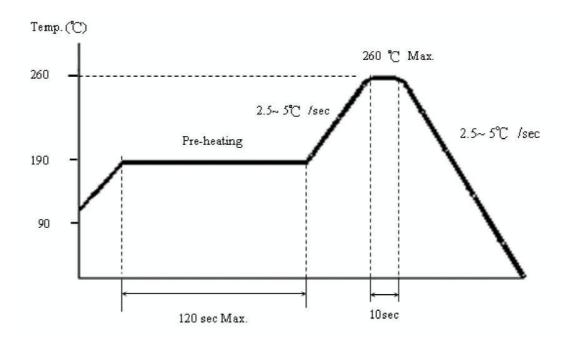
11. SOLDERING CONDITIONS:

(1) Recommended Re-flow profile

(A) Lead Solder Profile

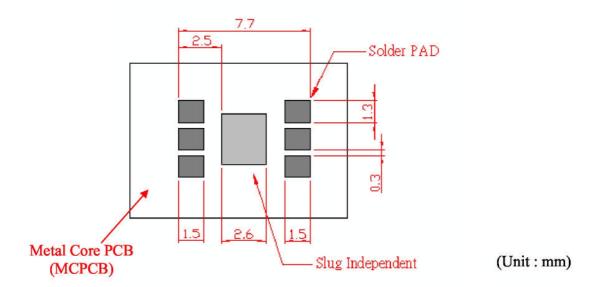


(B) Lead-free Solder Profile



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Recommended Soldering Pad



- (2) Re-flow soldering should not be done more than two times.
- (3) It is recommended that the user use the nitrogen reflow method.
- (4) When soldering, don't put stress on the LEDs during heating.
- (5) After soldering, don't warp the circuit board.
- (6) It is recommended that isopropyl alcohol (IPA) be used as a solvent for cleaning the LEDs.

12.CAUTIONS:

(1)Storage

• Before opening the package:

The LEDs should be kept at 30°C or less and 30%RH~85%RH. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with desiccant (Silica gel) is recommended.

• After opening the package:

The LEDs should be kept at 30°C or less and 30%RH~70%RH. The LEDs should be soldered within 168hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture desiccant (Silica ge1), or reseal the moisture proof bag again. If the moisture desiccant (Silica ge1) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 24 hours at 60°C on tap and reel, 3 hours at 125°C have no reel&tap. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration might lower solderability or might effect on optical characteristics.-Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

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• Moisture Proof package

When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package. A package of a moisture desiccant (silica gel)is inserted into the moisture proof bag-The silica gel changes its color from blue to pink as it absorbs moisture.

(2)Static Electricity

- Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an anti-electrostatic glove and shoe be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- when inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to End static-damaged LEDs by a light-on test or a VF test at a lower current (below l mA).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

(3)Heat Generation

- Please consider the heat generation of the LED when making the system design that it's very importance. The coefficient of temperature increase per input electric power is effected by the thermal resistance of the circuit board and density of LED placement on the board, and other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4)Others

- Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly for more than a few seconds. Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.

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